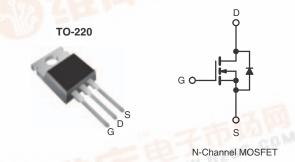


Vishay Siliconix

WWW.DZSC **Power MOSFET**

PRODUCT SUMMARY					
V _{DS} (V)	600				
$R_{DS(on)}\left(\Omega\right)$	V _{GS} = 10 V	4.4			
Q _g (Max.) (nC)	18				
Q _{gs} (nC)	3.0				
Q _{gd} (nC)	8.9				
Configuration	Single				



FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Lead (Pb)-free Available



Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220 contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION		
Package	TO-220	
Lead (Pb)-free	IRFBC20PbF	m.
	SiHFBC20-E3	
SnPb	IRFBC20	
	SiHFBC20	

ABSOLUTE MAXIMUM RATINGS T	_C = 25 °C, u	nless otherw	rise noted			
PARAMETER		SYMBOL	LIMIT	UNIT		
Drain-Source Voltage			V_{DS}	600	V	
Gate-Source Voltage			V_{GS}	± 20	V	
Continuous Drain Current	V _{GS} at 10 V	T _C = 25 °C	1-	2.2	А	
		T _C = 100 °C	I _D	1.4		
Pulsed Drain Current ^a			I _{DM}	8.0		
Linear Derating Factor				0.40	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	84	mJ	
Repetitive Avalanche Currenta			I _{AR}	2.2	Α	
Repetitive Avalanche Energy ^a		132	E _{AR}	5.0	mJ	
Maximum Power Dissipation	T _C =	25 °C	P _D	50	W	
Peak Diode Recovery dV/dtc	D NOOM		dV/dt	3.0	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150		
Soldering Recommendations (Peak Temperature)	for 10 s			300 ^d	°C	
- 1/2	0.001			10	lbf ⋅ in	
Mounting Torque	6-32 or M3 screw			1.1	N·m	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. V_{DD} = 50 V, starting T_J = 25 °C, L = 31 mH, R_G = 25 Ω , I_{AS} = 2.2 A (see fig. 12).
- c. $|s_D \le 2.2$ A, dl/dt ≤ 40 A/ μ s, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C. d. 1.6 mm from case.
- Po containing terminations are not RoHS compliant, exemptions may apply

Document Number: 91106 www.vishay.com



RoHS

COMPLIANT

Vishay Siliconix



THERMAL RESISTANCE					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	62		
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50	-	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	2.5		

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		•					
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	ce to 25 °C, I _D = 1 mA	-	0.88	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}	,	V _{GS} = ± 20 V		-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}		V _{DS} = 600 V, V _{GS} = 0 V V _{DS} = 480V, V _{GS} = 0 V, T _J = 125 °C		-	100 500	μΑ
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 1.3 A ^b	-	-	4.4	Ω
Forward Transconductance	9fs	V _{DS} =	= 50 V, I _D = 1.3 A ^b	1.4	-	-	S
Dynamic							
Input Capacitance	C _{iss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ $f = 1.0 \text{ MHz}, \text{ see fig. 5}$		-	350	-	pF
Output Capacitance	C _{oss}			-	48	-	
Reverse Transfer Capacitance	C _{rss}			-	8.6	-	
Total Gate Charge	Qg		I _D = 2.0 A, V _{DS} = 360 V see fig. 6 and 13 ^b	-	-	18	nC
Gate-Source Charge	Q _{gs}			-	-	3.0	
Gate-Drain Charge	Q_{gd}			-	-	8.9	
Turn-On Delay Time	$t_{d(on)}$			-	10	-	- ns
Rise Time	t _r	V _{DD} =	V _{DD} = 300 V, I _D = 2.0 A		23	-	
Turn-Off Delay Time	t _{d(off)}	R_G = 18 Ω, R_D = 150 Ω see fig. 10 ^b		-	30	-	
Fall Time	t _f			-	25	-	
Internal Drain Inductance	L_D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	- nH
Internal Source Inductance	L _S			-	7.5	-	
Drain-Source Body Diode Characteristic	s	•				•	
Continuous Source-Drain Diode Current	I _S	showing the	MOSFET symbol showing the		-	2.2	A
Pulsed Diode Forward Current ^a	I _{SM}	integral reverse p - n junction diode		-	-	8.0	
Body Diode Voltage	V_{SD}	T _J = 25 °C, I _S = 2.2 A, V _{GS} = 0 V ^b		-	-	2.0	V
Body Diode Reverse Recovery Time	t _{rr}	$T_J = 25 ^{\circ}\text{C}, I_F = 2.0 \text{A},$		-	290	580	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$dI/dt = 100 \text{ A/µs}^b$		-	0.67	1.3	μС
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L _S and				y L _S and	L _D)

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width \leq 300 μ s; duty cycle \leq 2 %.

www.vishav.com Document Number: 91106



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

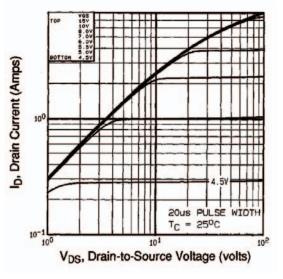


Fig. 1 - Typical Output Characteristics, $T_C = 25$ °C

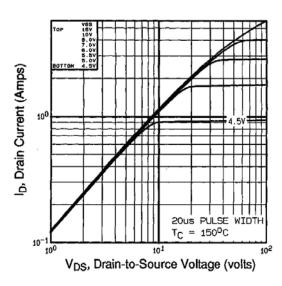


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

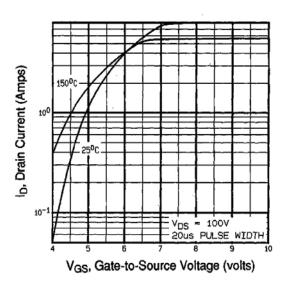


Fig. 3 - Typical Transfer Characteristics

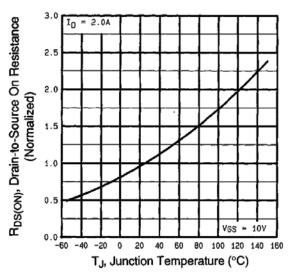


Fig. 4 - Normalized On-Resistance vs. Temperature

Document Number: 91106 www.vishay.com

Vishay Siliconix



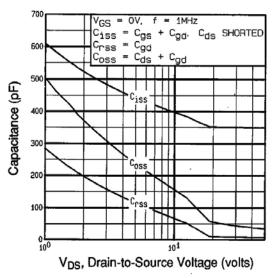


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

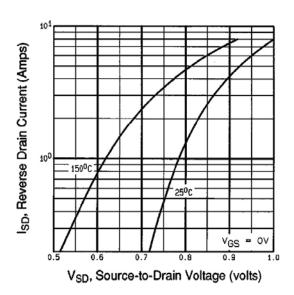


Fig. 7 - Typical Source-Drain Diode Forward Voltage

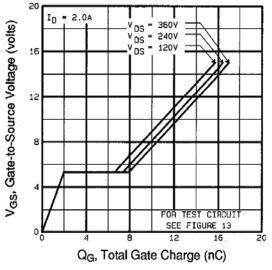


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

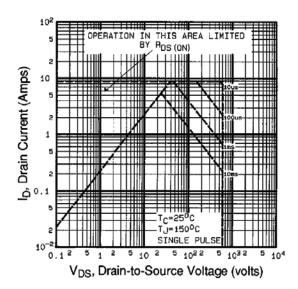


Fig. 8 - Maximum Safe Operating Area

www.vishay.com Document Number: 91106



Vishay Siliconix

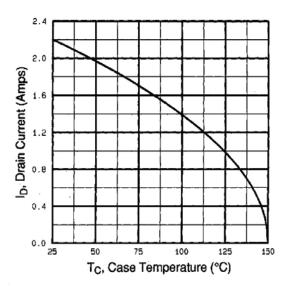


Fig. 9 - Maximum Drain Current vs. Case Temperature

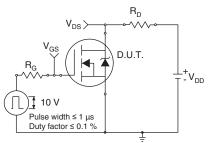


Fig. 10a - Switching Time Test Circuit

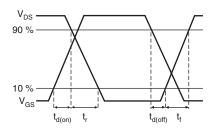


Fig. 10b - Switching Time Waveforms

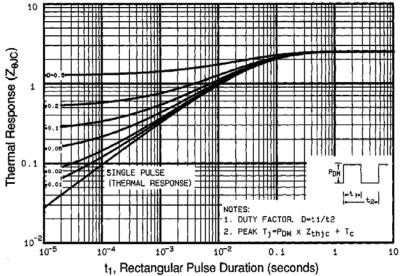


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

Document Number: 91106 www.vishay.com

Vishay Siliconix



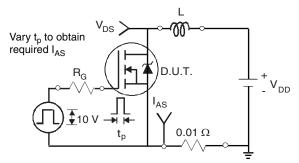


Fig. 12a - Unclamped Inductive Test Circuit

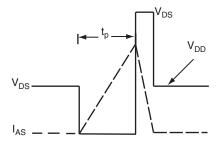


Fig. 12b - Unclamped Inductive Waveforms

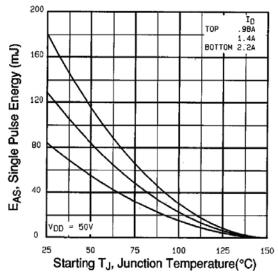


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

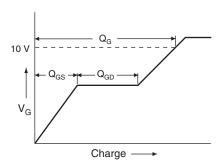


Fig. 13a - Basic Gate Charge Waveform

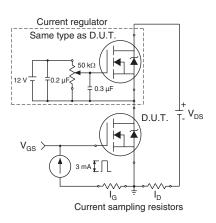
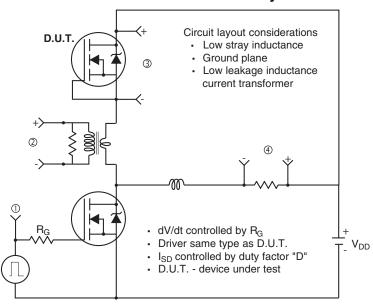


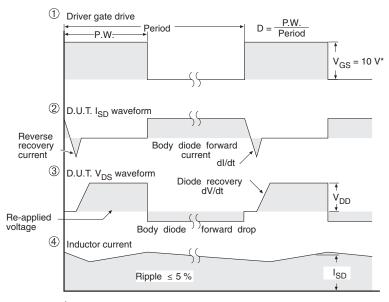
Fig. 13b - Gate Charge Test Circuit

www.vishay.com Document Number: 91106

Vishay Siliconix

Peak Diode Recovery dV/dt Test Circuit





* $V_{GS} = 5 V$ for logic level devices

Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?91106.

Document Number: 91106 www.vishay.com



Vishay

Disclaimer

All product specifications and data are subject to change without notice.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained herein or in any other disclosure relating to any product.

Vishay disclaims any and all liability arising out of the use or application of any product described herein or of any information provided herein to the maximum extent permitted by law. The product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein, which apply to these products.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications unless otherwise expressly indicated. Customers using or selling Vishay products not expressly indicated for use in such applications do so entirely at their own risk and agree to fully indemnify Vishay for any damages arising or resulting from such use or sale. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

Product names and markings noted herein may be trademarks of their respective owners.

Document Number: 91000 www.vishay.com